



INTERNATIONAL
GEMOLOGICAL
INSTITUTE

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LABORATORY GROWN DIAMOND REPORT

May 29, 2026

IGI Report Number

Description

Shape and Cutting Style

Measurements

GRADING RESULTS

Carat Weight

Color Grade

Clarity Grade

ADDITIONAL GRADING INFORMATION

Polish

Symmetry

Fluorescence

Inscription(s)

Comments: As Grown - No indication of post-growth treatment.
This Laboratory Grown Diamond was created by High Pressure High Temperature (HPHT) growth process. Type II

LG799645084

Report verification at [igi.org](#)

PROPORTIONS

Medium

62%

13.5%

49.5%

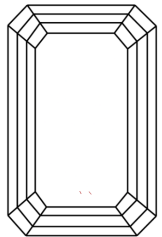
65.6%

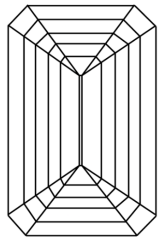
Long

Sample Image Used

IGI LG799645084

CLARITY CHARACTERISTICS





KEY TO SYMBOLS

Red symbols indicate internal characteristics.
Green symbols indicate external characteristics.

COLOR

D E F G H I J Faint Very Light Light

CLARITY

FL IF VVS ¹⁻² VS ¹⁻² SI ¹⁻² I ¹⁻³

Flawless Internally Flawless Very Very Slightly Included Very Slightly Included Slightly Included Included

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IGI

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EMERALD CUT

10.40 X 7.39 X 4.85 MM

3.58 CARATS

D

VVS 2

65.6%

62%

Medium

Long

EXCELLENT

EXCELLENT

NONE

IGI LG799645084

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www.igi.org

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